MGV201610S2R2M-10

PHYSICAL DIMENSIONS:

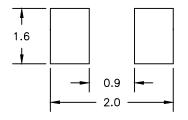
A 2.00 ± 0.20

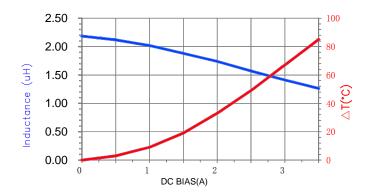
B 1.60 ± 0.20

C 1.00 Max.

D 0.50 ± 0.30

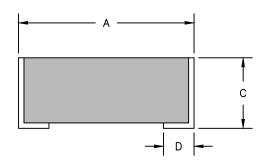
LAND PATTERNS FOR REFLOW SOLDERING



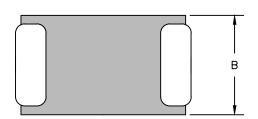


ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max	
INDUCTANCE (uH) L @ 1MHz/1mA ±20%	1.76	2.20	2.64	
DCR (Ω)		0.117	0.140	
Saturation Current Isat (A)		2.60	2.45	
Heating Current Irms (A)		2.20	2.00	







NOTES:

- 1. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. OPERATING TEMPERATURE RANGE: $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$.
- 4. STORAGE TEMPERATURE RANGE: -50°C ~ +125°C .
- 5. ISat MEANS THAT MAX DC CURRENT WILL CAUSE A PROXIMATELY 30% INDUCTANCE REDUCTION FROM INITIAL VALUE.
- 6. Irms MEANS THAT MAX DC CURRENT WILL CAUSE PROXIMATELY 40°C TEMPERATURE RISE FROM 25±5°C AMBIENT.

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	DIMENSIONS ARE IN mm.			This print is the property of Laird					
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					copies shall be made without the		Laird		3
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